ONYX® 14" DC / IC Target | MAG.II

US Specifications

Construction

Anode	304 Stainless Steel
Cathode Body	OFHC Copper
Insulator	Consult Factory

Cooling Requirements

Flow Rate at Maximum Power	Consult Factory
Maximum Input Pressure, Open Drain	Consult Factory
Maximum Input Temperature	Consult Factory

Dimensions

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Α	Consult Factory	⊬———B—————————————————————————————————
В	Consult Factory	
С	Consult Factory	
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General

Magnetic Enhancement	Permanent (NdFeB) Encapsulated
Maximum Temperature	Consult Factory
Source to Substrate Distance	Consult Factory
Weight, Approximate Without Options	Consult Factory

Maximum Sputtering Power *

Cathode Voltage	Consult Factory
Direct Cooled Mode, DC	Consult Factory
Direct Cooled Mode, RF	Consult Factory
Discharge Current	Consult Factory
Indirect Cooled Mode, DC	Consult Factory
Indirect Cooled Mode, RF	Consult Factory
Operating Pressure	Consult Factory

Mounting, Standard

Power Cable, DC	Consult Factory
Power Cable, RF	Consult Factory
Power Connector, DC	Consult Factory
Power Connector, RF	Consult Factory
Stem, Outer Dimension Tubing	Consult Factory
Water, Outer Dimension Tubing	Consult Factory
Target	
Cooling	Direct / Indirect

Cooling	Direct / Indirect
Diameter	Consult Factory
Form	Circular / Planar
Thickness, Magnetic	Consult Factory
Thickness, Non-Magnetic	Consult Factory

Specifications Disclaimer

- All Angstrom Sciences NdFeB magnets are totally encapsulated and protected from degradation by water.
- All sources are available in external configurations.
- Magnetic material calculations are optimized with Nickel targets.
- * Maximum power for cathode only, a target material's properties, such as, thermal and electrical conductivity may limit the maximum process power level.
- · Some custom-engineered and specialty magnetrons may not meet standard specifications.
- · Specifications are subject to change without notice.
- Thickness will vary depending upon coercivity of target material.
- · Typical performance. Results may vary with process parameters such as pressure, flow rate, target material, and substrate rotation, etc.

Please contact us for specifications regarding your application.

Angstrom Sciences | Call +1-412-469-8466 | www.angstromsciences.com